### General Description

Maxim's redesigned DG444/DG445 analog switches now feature on-resistance matching (4 $\Omega$  max) between switches and guaranteed on-resistance flatness over the signal range (9 $\Omega$  max). These low on-resistance switches conduct equally well in either direction. They guarantee low charge injection (10pC max), low power consumption (35µW max), and an ESD tolerance of 2000V minimum per Method 3015.7. The new design offers lower off leakage current over temperature (less than 5nA at +85°C).

The DG444/DG445 are quad, single-pole/single-throw (SPST) analog switches. The DG444 has 4 normally closed switches and the DG445 has 4 normally open switches. Switching times are less than 250ns for toN and less than 70ns for toFF. Operation is from a single +10V to +30V supply, or bipolar  $\pm$ 4.5V to  $\pm$ 20V supplies. Maxim's improved DG444/DG445 continue to be fabricated with a 44V silicon-gate process.

	_Applications
Sample-and-Hold Circuits	Communication Systems
Test Equipment	Battery-Operated Systems
Heads-Up Displays	PBX, PABX
Guidance and Control Systems	Audio Signal Routing
Military Radios	Modems/Faxes

### \_New Features

- Plug-In Upgrades for Industry-Standard DG444/DG445
- Improved ron Match Between Channels (4Ω max)
- Guaranteed rFLAT(ON) Over Signal Range (9Ω max)
- Improved Charge Injection (10pC max)
- Improved Off Leakage Current Over Temperature (<5nA at +85°C)</li>
- Withstand Electrostatic Discharge (2000V min) per Method 3015.7

### \_Existing Features

- Low rDS(ON) (85Ω max)
- Single-Supply Operation +10V to +30V Bipolar-Supply Operation ±4.5V to ±20V
- Low Power Consumption (35µW max)
- Rail-to-Rail Signal Handling
- TTL/CMOS-Logic Compatible

### \_Ordering Information

TEMP. RANGE	PIN-PACKAGE
0°C to +70°C	16 Plastic DIP
0°C to +70°C	16 Narrow SO
0°C to +70°C	Dice*
-40°C to +85°C	16 Plastic DIP
-40°C to +85°C	16 Narrow SO
	0°C to +70°C 0°C to +70°C 0°C to +70°C -40°C to +85°C

**Ordering Information continued at end of data sheet.** \* Contact factory for dice specifications.

TOP VIEW IN1 IN1 6 IN2 IN2 D1 5 D2 D1 5 D2 S1 4 S2 S1 4 S2 V-V+ V-3 V+ 3 1/XL MAXIM 12 VL GND 5 DG4442  $V_{\mathsf{L}}$ GND S4 1 S3 S4 1 S3 0 D3 10 D3 D4 7 D4 IN4 IN3 9 IN3 IN4 DIP/SO DIP/SO DG444 DG445 SWITCH LOGIC LOGIC SWITCH 0 ON 0 OFF OFF ON SWITCHES SHOWN FOR LOGIC "0" INPUT

### \_Pin Configurations/Functional Diagrams/Truth Tables

### 

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### ABSOLUTE MAXIMUM RATINGS Voltage Referenced to V-

Voltage Referenced to V-	Continuous Power Dissipation ( $T_A = +70^{\circ}C$ )
V+	16-Pin Plastic DIP (derate 10.53mW/°C above +70°C) 842mW
GND25V	16-Pin Narrow SO (derate 8.70mW/°C above +70°C)696mW
VL(GND -0.3V) to (V+ +0.3V)	Operating Temperature Ranges
Digital Inputs V <sub>S</sub> , V <sub>D</sub> (Note 1)(V2V) to (V+ +2V) or 30mA	DG444C/DG445C0°C to +70°C
(whichever occurs first)	DG444D/DG445D40°C to +85°C
Continuous Current (any terminal)	Storage Temperature Range65°C to +150°C
Peak Current, S or D (pulsed at 1ms, 10% duty cycle max) .100mA	Lead Temperature (soldering, 10sec)+300°C

Note 1: Signals on S, D, or IN exceeding V+ or V- are clamped by internal diodes. Limit forward current to maximum current rating.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **ELECTRICAL CHARACTERISTICS—Dual Supplies**

 $(V_{+} = 15V, V_{-} = -15V, V_{L} = 5V, GND = 0V, V_{INH} = 2.4V, V_{INL} = 0.8V, T_{A} = T_{MIN}$  to T<sub>MAX</sub>, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP (Note 2)	МАХ	UNITS
SWITCH	1						
Analog Signal Range	Vanalog	(Note 3)		-15		15	V
Drain-Source		V+ = 13.5V, V- = -13.5V,	$T_A = +25^{\circ}C$		50	85	Ω
On-Resistance	rds(on)	$V_D = \pm 8.5V,$ IS = -10mA	T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>			100	
On-Resistance Match	Areason	Vp = ±10V.	$T_A = +25^{\circ}C$			4	- Ω
Between Channels (Note 4)	$\Delta r_{DS(ON)}$	Is = -10mA	$T_A = T_{MIN}$ to $T_{MAX}$			5	
On Desistance Flatness (Note 4)	rflat(on)	$V_D = \pm 5V,$ $I_S = -10mA$	$T_A = +25^{\circ}C$			9	- Ω
On-Resistance Flatness (Note 4)			$T_A = T_{MIN}$ to $T_{MAX}$			15	
Source Leakage Current (Note 5)	IS(OFF)	$\begin{array}{l} V{}+{}={}16.5V,V{}{}-{}={}-{}16.5V,\\ V{}_{D}{}={}15.5V,\\ V{}_{S}{}={}15.5V \end{array}$	$T_A = +25^{\circ}C$	-0.50	0.01	0.50	- nA
			$T_A = T_{MIN}$ to $T_{MAX}$	-5		5	
Drain-Off Leakage Current		$V_{+} = 16.5V, V_{-} = -16.5V,$	$T_A = +25^{\circ}C$	-0.50	0.01	0.50	m A
(Note 5)	ID(OFF)	$V_D = \pm 15.5V,$ $V_S = \mp 15.5V$	T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>	-5		5	- nA
Drain-On Leakage Current (Note 5)	I <sub>D(ON)</sub> or I <sub>S(ON)</sub>	$\begin{array}{l} V{}+{}={}16.5V,V{}-{}={}{-}16.5V,\\ V{}_{D}{}={}15.5V,\\ V{}_{S}{}={}15.5V \end{array}$	T <sub>A</sub> = +25°C	-0.50	0.08	0.50	- nA
			$T_A = T_{MIN}$ to $T_{MAX}$	-10		10	
INPUT			1				
Input Current with Input Voltage High	linh	V <sub>IN</sub> = 2.4V, all others = 0.8V		-0.5	-0.00001	0.5	μA
Input Current with Input Voltage Low	linl	$V_{IN} = 0.8V$ , all others = 2.4V		-0.5	-0.00001	0.5	μΑ

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PARAMETER	SYMBOL	CONDITIONS			TYP (Note 2)	MAX	UNITS	
SUPPLY								
Power-Supply Range	V+, V-			±4.5		±20.0	V	
Positive Supply Current	+	All channels on or off, $V_{+} = 16.5V$ , $V_{-} = -16.5V$ ,	$T_A = +25^{\circ}C$	-1	0.001	1	μA	
rostive Supply Current	17	$V_{IN} = 0V \text{ or } 5V$	$T_A = T_{MIN}$ to $T_{MAX}$	-5		5	μΑ	
Negative Supply Current	-	All channels on or off, $V_{+} = 16.5V$ , $V_{-} = -16.5V$ ,	$T_A = +25^{\circ}C$	-1	-0.0001	1		
Negative Supply Current	1-	$V_{\rm IN} = 0V \text{ or } 5V$	$T_A = T_{MIN}$ to $T_{MAX}$	-5		5	μA	
Logic Supply Current	lı	All channels on or off, $V_{+} = 16.5V$ , $V_{-} = -16.5V$ ,	$T_A = +25^{\circ}C$	-1	0.001	1		
Logic Supply Current	IL IL	$V_{\rm IN} = 0V \text{ or } 5V$	T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>	-5		5	μΑ	
Ground Current		All channels on or off, $V_{+} = 16.5V$ , $V_{-} = -16.5V$ ,	$T_A = +25^{\circ}C$	-1	-0.0001	1		
Ground Current IGND		V = 10.5V, V = -10.5V, $V_{IN} = 0V \text{ or } 5V$	T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>	-5		5	μΑ	
DYNAMIC								
Turn-On Time	ton	$V_S = \pm 10V$ , Figure 2	$T_A = +25^{\circ}C$		150	250	ns	
Turn-Off Time	toff	DG444, V <sub>S</sub> = $\pm 10V$ , Figure 2	$T_A = +25^{\circ}C$		90	120	ns	
rum-on nine	UFF	DG445, V <sub>S</sub> = $\pm 10V$ , Figure 2	$T_A = +25^{\circ}C$		110	170	ns	
Charge Injection (Note 3)	Q	$C_L = 1nF$ , $V_{GEN} = 0V$ , R <sub>GEN</sub> = 0 $\Omega$ , Figure 3	T <sub>A</sub> = +25°C		5	10	рС	
Off-Isolation Rejection Ratio (Note 6)	OIRR	$R_L = 50\Omega$ , $C_L = 5pF$ , f = 1MHz, Figure 4	T <sub>A</sub> = +25°C		60		dB	
Crosstalk (Note 7)		$R_L - 50\Omega$ , $C_L = 5pF$ , f = 1MHz, Figure 5	T <sub>A</sub> = +25°C		100		dB	
Source-Off Capacitance	Cs(OFF)	f = 1MHz, Figure 6	$T_A = +25^{\circ}C$		4		рF	
Drain-Off Capacitance	CD(OFF)	f = 1MHz, Figure 6	$T_A = +25^{\circ}C$		4		рF	
Source-On Capacitance	Cs(ON)	f = 1MHz, Figure 7	$T_A = +25^{\circ}C$		16		рF	
Drain-On Capacitance	CD(ON)	f = 1MHz, Figure 7	T <sub>A</sub> = +25°C		16		рF	

**ELECTRICAL CHARACTERISTICS—Dual Supplies (continued)** (V+ = 15V, V- = -15V, V<sub>L</sub> = 5V, GND = 0V, V<sub>INH</sub> = 2.4V, V<sub>INL</sub> = 0.8V, T<sub>A</sub> = T<sub>MIN</sub> to T<sub>MAX</sub>, unless otherwise noted.)

# DG444/DG445

### **ELECTRICAL CHARACTERISTICS—Single Supply**

 $(V + = 12V, V - = 0V, V_L = 5V, GND = 0V, V_{INH} = 2.4V, V_{INL} = 0.8V, T_A = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.)

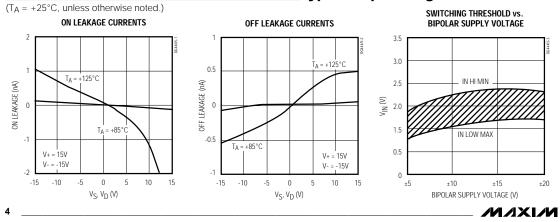
PARAMETER	SYMBOL	CONDITIONS		MIN	TYP (Note 2)	MAX	UNITS
SWITCH							
Analog Signal Range	VANALOG	(Note 3)		0		12	V
Drain-Source	rds(on)	$V_{+} = 10.8V,$ $V_{L} = 5.25V,$	$T_{A} = +25^{\circ}C$		100	160	Ω
On-Resistance	105(014)	V <sub>D</sub> = 3V, 8V, I <sub>S</sub> = -10mA	$T_A = T_{MIN}$ to $T_{MAX}$			200	52
SUPPLY							
Power-Supply Range	V+, V-			10.8		24.0	V
Dower Supply Current	+	All channels on or off, $V_{IN} = 0V$ or $5V$	$T_A = +25^{\circ}C$	-1	0.001	1	μA
Power-Supply Current			TA = TMIN to TMAX	-5		5	
$\label{eq:loss} \begin{array}{c} \mbox{Negative Supply Current} \\ \mbox{I-} \\ \mbox{I}_{N} = 0 \mbox{V or 5V} \end{array}$	1	All channels on or off,	$T_A = +25^{\circ}C$	-1	-0.0001	1	
	VIN = 0V  or  5V	TA = TMIN to TMAX	-5		5	μA	
Logic Supply Current	Sumply Company	All channels on or off,	TA = +25°C	-1	0.001	1	
Logic Supply Current	bgic Supply Current $I_L$ $V_{IN} = 0V \text{ or } 5V$		TA = TMIN to TMAX	-5		5	-μΑ
Ground Current	loup	All channels on or off,	$T_A = +25^{\circ}C$	-1	-0.0001	1	
	Ignd	$V_{IN} = 0V \text{ or } 5V$	TA = TMIN to TMAX	-5		5	μA
DYNAMIC	•			•			
Turn-On Time	ton	V <sub>S</sub> = 8V, Figure 2	TA = +25°C		300	400	ns
Turn-Off Time	toff	V <sub>S</sub> = 8V, Figure 2	$T_A = +25^{\circ}C$		60	200	ns
Charge Injection (Note 3)	Q	$C_L = 1nF$ , $V_{GEN} = 0V$ , $R_{GEN} = 0\Omega$ , Figure 3	T <sub>A</sub> = +25°C		5	10	рС

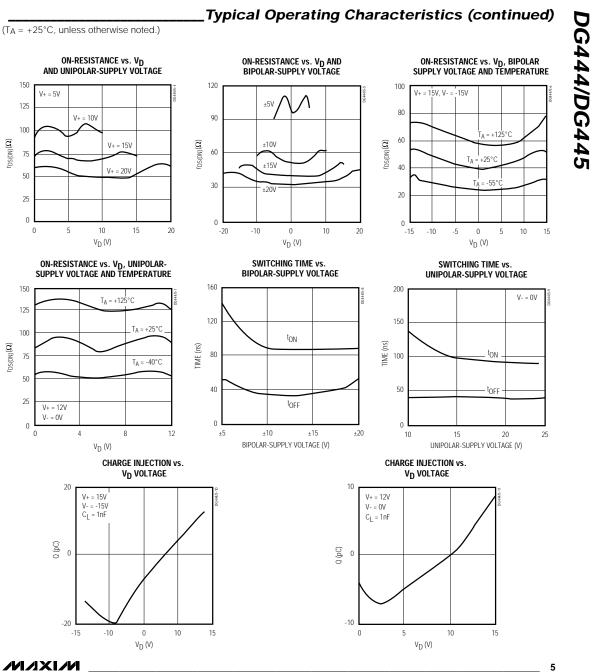
Note 2: Typical values are for design aid only, are not guaranteed and are not subject to production testing. The algebraic convention, where the most negative value is a minimum and the most positive value a maximum, is used in this data sheet. Note 3: Guaranteed by design.

Note 4: On-resistance match between channels and flatness are guaranteed only with bipolar-supply operation. Flatness is defined as the difference between the maximum and the minimum value of on-resistance as measured at the extremes of the specified analog signal range.

Note 5: Leakage parameters  $S_{(OFF)}$ ,  $D_{(OFF)}$ ,  $D_{(ON)}$ , and  $IS_{(ON)}$ , are100% tested at the maximum rated hot temperature and guaranteed at +25°C. Note 6: Off-Isolation Rejection Ratio = 20log ( $V_D/V_S$ ),  $V_D$  = output,  $V_S$  = input to off switch. Note 7: Between any two switches.

### **Typical Operating Characteristics**





Pin	Description
-----	-------------

PIN	NAME	FUNCTION
1, 16, 9, 8	IN1-IN4	Logic Control Inputs
2, 15, 10, 7	D1-D4	Drain Outputs
3, 14, 11, 6	S1-S4	Source Outputs
4	V-	Negative Supply-Voltage Input
5	GND	Ground
12	VL	Logic Supply-Voltage Input
13	V+	Positive Supply-Voltage Input— connected to substrate

### Applications Information

- General Operation
- 1. Switches are open when power is off.
- IN, D, and S should not exceed V+ or V-, even with the power off.
- 3. Switch leakage is from each analog switch terminal to V+ or V-, not to other switch terminals.

### Operation with Supply Voltages Other Than ±15V

Using supply voltages other than  $\pm 15V$  will reduce the analog signal range. The DG444/DG445 switches operate with  $\pm 4.5V$  to  $\pm 20V$  bipolar supplies or with a  $\pm 10V$  to  $\pm 30V$  single supply: connect V- to 0V when operating with a single supply. Also, all device types can operate with unbalanced supplies such as  $\pm 24V$  and  $\pm 5V$ . VL must be connected to  $\pm 5V$  to be TTL compatible, or to V+ for CMOS-logic level inputs. The *Typical Operating* 

Characteristics graphs show typical on-resistance with  $\pm 20V$ ,  $\pm 15V$ ,  $\pm 10V$ , and  $\pm 5V$  supplies. (Switching times increase by a factor of two or more for operation at  $\pm 5V$ .)

### **Overvoltage Protection**

Proper power-supply sequencing is recommended for all CMOS devices. Do not exceed the absolute maximum ratings because stresses beyond the listed ratings may cause permanent damage to the devices. Always sequence V+ on first, followed by V<sub>L</sub>, V-, and logic inputs. If power-supply sequencing is not possible, add two small, external signal diodes in series with supply pins for overvoltage protection (Figure 1). Adding diodes reduces the analog signal range to 1V below V+ and 1V above V-, but low switch resistance and low leakage characteristics are unaffected. Device operation is unchanged, and the difference between V+ and V-should not exceed +44V.

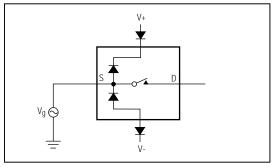
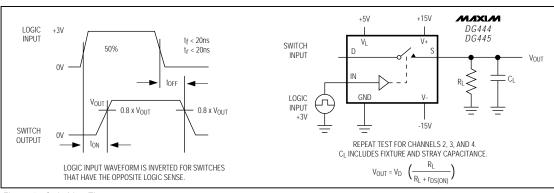


Figure 1. Overvoltage Protection Using External Blocking Diodes

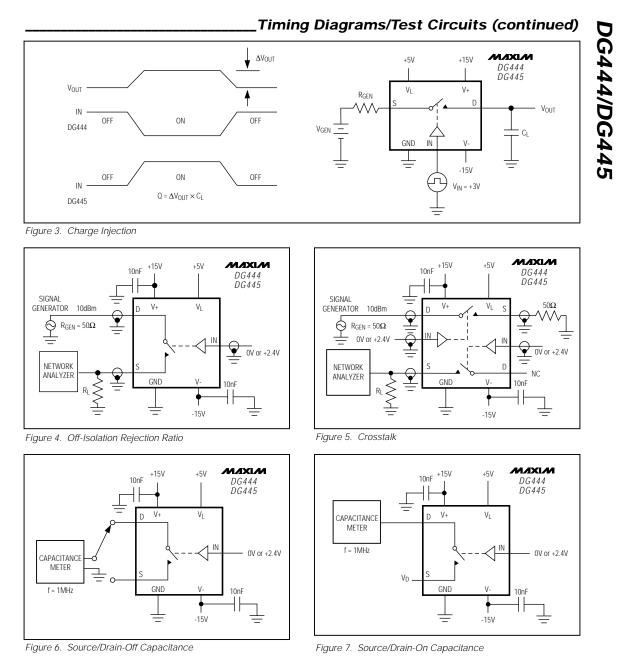


### Timing Diagrams/Test Circuits

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Figure 2. Switching Time

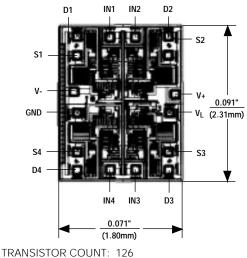


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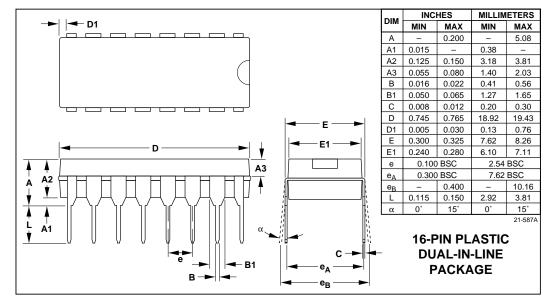
_Orderin	g Information	(continued)
PART	TEMP. RANGE	PIN-PACKAGE
DG445CJ	0°C to +70°C	16 Plastic DIP
DG445CY	0°C to +70°C	16 Narrow SO
DG445C/D	0°C to +70°C	Dice*
DG445DJ	-40°C to +85°C	16 Plastic DIP
DG445DY	-40°C to +85°C	16 Narrow SO
* Contact factory	for dice specifications.	





SUBSTRATE CONNECTED TO V+

Package Information



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